# YIDONG REN

+1-517-219-6227 | renyidon@msu.edu | https://ydren001.github.io/

428 S. Shaw Lane, East Lansing, MI - 48824, USA

#### RESEARCH INTERESTS

- Sustainable IoT System: Satellite IoT in rural areas [MobiCom'24 C2]. Cross-soil agricultural IoT [MobiCom'24 C3].
- AI for wireless: Neural enhanced signal encoder decoder co-design [MobiSys'24, MobiHoc'23, ICLR'23 ML4IoT].
- Wireless Physical Layer: Batteryless communication [INFOCOM'23, 25]. LoRa demodulation [MobiCom'24 C7].
- Mobile Computing: Wearable system authentication [SenSys'24]. Channel adapted WiFi [TMC'22]

### **EDUCATION**

Michigan State University

East Lansing, USA

Ph.D. Candidate, Department of Computer Science and Engineering

2021 - Present

Advisor: Zhichao Cao

University of Electronic Science and Technology of China

Chengdu, China

B.E., Electronic and Information Engineering

2017 - 2021

## **CONFERENCE PUBLICATIONS**

\* denotes equal contribution, \_ are students I mentor

First-author papers:

INFOCOM 2025 [C1] AeroEcho: Towards Agricultural Low-power Wide-area Backscatter with Aerial Excitation

Source.

Yidong Ren, Gen Li, Yimeng Liu, Younsuk Dong, Zhichao Cao

IEEE Conference on Computer Communications, 2025

*Acceptance ratio:* 18.66%

MobiCom 2024 [C2] SateRIoT: High-performance Ground-Space Networking for Rural IoT.

Yidong Ren, Amalinda Gamage, Li Liu, Mo Li, Shigang Chen, Younsuk Dong, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiCom 2024 [C3] Demeter: Reliable Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

Yidong Ren, Wei Sun, Jialuo Du, Huaili Zeng, Younsuk Dong, Mi Zhang, Shigang Chen, Yunhao

Liu, Tianxing Li, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

MobiSys 2024 [C4] ChirpTransformer: Versatile LoRa Encoding for Low-power Wide-area IoT.

Yidong Ren\* (co-primary author), Chenning Li\*, Shuai Tong, Shakhrul Iman Siam, Mi Zhang,

Jiliang Wang, Yunhao Liu, Zhichao Cao.

The 22nd ACM International Conference on Mobile Systems, Applications, and Services

Acceptance ratio: 16.35%

[C5] Prism: High-throughput LoRa Backscatter with Non-linear Chirps. **INFOCOM 2023** 

Yidong Ren, Puyu Cai, Jinyan Jiang, Jialuo Du, Zhichao Cao.

IEEE Conference on Computer Communications, 2023

Acceptance ratio: 19.21%

**ICNP 2022** [C6] Is Lorawan Really Wide? Fine-grained LoRa Link-level Measurement in An Urban Environ-

Yidong Ren\* (co-primary author), Li Liu\*, Chenning Li\*, Zhichao Cao and Shigang Chen.

The 30th IEEE International Conference on Network Protocols.

Acceptance ratio: 21.43%

Other papers:

MobiCom 2024 [C7] LoRaTrimmer: Optimal Energy Condensation with Chirp Trimming for LoRa Weak Signal

Jialuo Du, Yunhao Liu, Yidong Ren, Li Liu, Zhichao Cao.

The 30th Annual International Conference On Mobile Computing And Networking.

Acceptance ratio: 20.85%

SenSys 2024 [C8] PiezoBud: A Piezo-Aided Secure Earbud with Practical Speaker Authentication.

Gen Li\*, Huaili Zeng\*, Hanqing Guo, Yidong Ren, Aiden Dixon, Zhichao Cao and Tianxing Li.

The 22nd ACM Conference on Embedded Networked Sensor Systems.

Acceptance ratio: 18.53%

MobiHoc 2023 [C9] SRLoRa: Neural-enhanced LoRa Weak Signal Decoding with Multi-gateway Super Resolu-

tion.

Jialuo Du, Yidong Ren, Zhuizhu, Chenning Li, Zhichao Cao, Qiang Ma, Yunhao Liu.

The 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for

Mobile Networks and Mobile Computing

Acceptance ratio: 22.06%

# JOURNAL PUBLICATIONS

TMC [J1] Morph: ChirpTransformer-based Encoder-decoder Co-design for Reliable LoRa Communication.

Yidong Ren, Maolin Gan, Mi Zhang, Shigang Chen, Zhichao Cao.

Under review of IEEE Transactions on Mobile Computing

TMC [J2] NELoRa: Towards Ultra-low SNR LoRa Communication with Neural-enhanced Demodulation.

Maolin Gan\*, Khang Nguyen\*, Jialuo Du, Yidong Ren, Huacheng Zeng, Mi Zhang, Shigang Chen,

Zhichao Cao.

Under review of ACM Transactions on Internet of Things

TMC [J3] Channel Adapted Antenna Augmentation for Improved Wi-Fi Throughput.

Yanbo Zhang, Weiping Sun, Yidong Ren, Sung-ju Lee, Mo Li.

IEEE Transactions on Mobile Computing, 2022.

## **BENCKMARK**

ICLR ML4IoT NELoRa-Bench: A Benchmark for Neural-enhanced LoRa Demodulation.

Jialuo Du, Yidong Ren, Mi Zhang, Yunhao Liu and Zhichao Cao.

International Conference on Learning Representations Workshop on Machine Learning for IoT,

2023. Oral

## **DEMO**

MobiCom 2024 Demeter-Demo: Demonstrating Cross-soil LPWAN with Low-cost Signal Polarization Alignment.

**Yidong Ren**, Yawen Wang, Younsuk Dong, Shigang Chen, Mi Zhang, Jiliang Tang, Zhichao Cao. The 30th Annual International Conference On Mobile Computing And Networking (**Demo**)

# **INTERNSHIP EXPERIENCE**

Qualcomm, WLAN System Team. Santa Clara, CA, USA

06/2024 - 09/2024

Research on DNN-assisted Wi-Fi CSI localization and Deep reinforcement learning for Wi-Fi roaming.

Nanyang Technological University, WADNS Group, Singapore

07/2019 - 10/2019

Channel adaptive Wi-Fi intelligent antenna selection system. Advisor: Mo Li

# TEACHING EXPERIENCE

Michigan State University, Department of Computer Science and Engineering

Teaching Assistant

CSE 220 — Programming in C

Spring 2022, Spring 2023, Spring 2024

CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2022

**Guest Lecturer** 

• CSE 891 — AIoT: Artificial Intelligence in the Edge

Fall 2023

## **ACADEMIC SERVICE**

#### Programm Committee of

USENIX Security Artifact Evaluation
 2025

ACM MobiCom Artifact Evaluation
 2024

ACM MobiSys Artifact Evaluation
 2024

ACM SenSys Artifact Evaluation
 2024

<ul> <li>IEEE International Conference on Parallel and Distribution</li> </ul>	ıted Systems (ICPADS)	2024
Invited Journal Reviewer of		
<ul> <li>IEEE/ACM Transactions on Networking</li> </ul>	2	2023-2024
IEEE Transactions on Mobile Computing		2024
<ul> <li>ACM Transactions on Sensor Network</li> </ul>	2	2022-2024
Conference Reviewer of		
• IEEE International Symposium on Dynamic Spectrum	Access Networks (DySpan)	2022-2023
• EAI MobiQuitous		2022
MENTORSHIP		
Puyu Cai	02/2022	2-12/2022
Now: Master student at Computer Science Department, New	v York University	
Khang Nguyen, Nam Nguyen	03/2023	- Present
Now: Honor College, Michigan State University		
HONOR AND AWARDS		
Dissertation Completion Fellowship, Graduate School at Mic	chigan State University	2025
Distinguished Artifact Reviewer, ACM MobiCom		2024
Student Travel Grant, ACM MobiCom Student Travel Grant, ACM MobiSys		2024 2024
Student Travel Grant, ACM MobiHoc		2024
Student Travel Grant, IEEE ICNP		2022
GRANTS EXPERIENCE		
I assisted in the preparation of proposals for the following re	search grants:	
<b>NSF:</b> LoRa Enabled Space-air-ground Integrated Networks for Award number 2338976.	or Next-Generation Agricultural IoT.	
<b>NSF:</b> Towards High-Performing LoRa with Embedded Intell Award number 2312674.	igence on the Edge.	
REFERENCES		
1. Zhichao Cao (Advisor)	Michigan State University	
Assistant Professor	Department of Computer Science and Eng	gineering
NSF CAREER AWARDEE		

NSF CAREER AWARDEE Email: caozc@msu.edu Phone: +1-517-353-3148

Shigang Chen
 Professor
 Department of Computer & Information of Science & Engineering

IEEE Fellow, ACM Distinguished Member

Email: sgchen@cise.ufl.edu Phone: +1-352-214-9215

3. Mo LiProfessorThe Hong Kong University of Science and TechnologyDepartment of Computer Science and Engineering,

IEEE Fellow, ACM Distinguished Member

Email: lim@cse.ust.hk Phone: +852 2358 7107

4. Yunhao Liu Tsinghua University
 Professor, Dean Global Innovation Exchange

ACM Fellow, IEEE Fellow Email: yunhao@tsinghua.edu.cn

Phone: +1-517-2495-850